IPC - ASSOCIATION CONNECTION ELECTRONICS INDUSTRIES	© Copyright 2005. IPO	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and M	ials and Mfc Information			
upplier Infori	mation											<u> </u>			
Company name*			Company unique ID			J	Unique ID Authority				Respon	Response Date*			
nsemi										2024-04	2024-04-20				
Contact Name			Title - Contact			I	Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			I	Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com			
Reques	Requester Item Number Mfr Iter		m Number Mfr Item Name			Effectiv		Versio	n :	Manufacturing Site		Weight*	UOM	Unit Type	
		LV8548MC-AH 2-ch Brush Motor		2-ch Brush Motor I	Driver		2024-04-20				72.0	mg	Each		
Ianufacturing	g Proccess Informati	on						·						·	
Terminal Plating / Grid Array Material Terminal B			erminal Base	minal Base Alloy J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak				k Tempera	ture Num	ber of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		C	CU Alloy 3				260		C	30	seco	nds 3			
omments															
TTENTION: MS	SL 3 Rated item requires	Bake and D	ry Pack (afte	r electrical test)											
or more informat	tion regarding material co	omposition p	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.61	mg	Supplier	Silicon (Si)	7440-21-3		2.6003	mg
			Supplier	Polyimide	Proprietary Data		0.0097	mg
Die Attach	0.28	mg		Epoxy resin	proprietary data		0.028	mg
			Supplier	Silver (Ag)	7440-22-4		0.224	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.028	mg
Lead Frame	37.62	mg	Supplier	Silver (Ag)	7440-22-4		0.79	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0752	mg
			Supplier	Iron (Fe)	7439-89-6		0.9367	mg
			Supplier	Copper (Cu)	7440-50-8		35.818	mg
Mold Compound-Black	29.51	mg		Epoxy resin	proprietary data		1.4755	mg
			Supplier	Phenol Resin	Proprietary Data		1.1804	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.951	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2951	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		23.608	mg
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg
Wire Bond - Cu	0.09	mg	Supplier	Copper (Cu)	7440-50-8		0.09	mg